

# <u>AP65N04DF</u>

### 40V N-Channel Enhancement Mode MOSFET

#### Description

The AP65N04DF uses advanced trench technology

to provide excellent R<sub>DS(ON)</sub>, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

#### **General Features**

V<sub>DS</sub> = 40V I<sub>D</sub> =65A

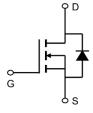
 $R_{DS(ON)} < 10 \text{m}\Omega @ V_{GS}=10V (Type: 8.0m\Omega)$ 

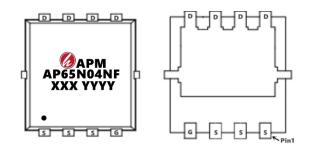
#### Application

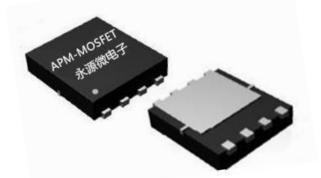
Battery protection

Load switch

Uninterruptible power supply







#### Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP65N04DF	PDFN3*3-8L	AP65N04DF XXX YYYY	5000

#### Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	40	V
Vgs	Gate-Source Voltage	±20	V
I <b>⊳@Tc=25°</b> C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	65	A
I₀@Tc=100℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	28	А
Ідм	Pulsed Drain Current <sup>2</sup>	180	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	81	mJ
las	Avalanche Current	10	А
P₀@T₀=25℃	Total Power Dissipation <sup>4</sup>	27.8	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R <sub>0</sub> JA	Thermal Resistance Junction-Ambient <sup>1</sup>	60	°C/W
R <sub>e</sub> jc	Thermal Resistance Junction-Case <sup>1</sup>	4.5	°C/W

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#### Electrical Characteristics (TJ=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	40			V
∆BVDSS/∆TJ	BVDSS Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.028		V/°C
RDS(ON)	Static Drain-Source On-Resistance	$V_{GS}$ =10V , I <sub>D</sub> =30A		8.0	10	mΩ
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		10	13	
VGS(th)	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.2	1.6	2.5	V
$ riangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient			-6.16		mV/°C
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =40V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA
1033		V <sub>DS</sub> =40V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	
IGSS	Gate-Source Leakage Current	$V_{GS}$ =±20V , $V_{DS}$ =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =30A		22		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7	3.4	Ω
Qg	Total Gate Charge (4.5V)			37		
Qgs	Gate-Source Charge	V <sub>DS</sub> =20V , V <sub>GS</sub> =10V , I <sub>D</sub> =25A		6		nC
Q <sub>gd</sub>	Gate-Drain Charge			7		1
Td(on)	Turn-On Delay Time			12		
Tr	Rise Time	$V_{DD}$ =30V , $V_{GS}$ =10V , $R_{G}$ =1 $\Omega$		12		ns
Td(off)	Turn-Off Delay Time	I <sub>D</sub> =25A		38		
T <sub>f</sub>	Fall Time			9		
Ciss	Input Capacitance			2400		
Coss	Output Capacitance	V <sub>DS</sub> =20V , V <sub>GS</sub> =0V , f=1MHz		192		pF
Crss	Reverse Transfer Capacitance			165		
ls	Continuous Source Current <sup>1,5</sup>				50	Α
ISM	Pulsed Source Current <sup>2,5</sup>	$V_G=V_D=0V$ , Force Current			200	Α
VSD	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V
t <sub>rr</sub>	Reverse Recovery Time			22		nS
Q <sub>rr</sub>	Reverse Recovery Charge	IF=30A , dI/dt=100A/µs ,Tյ=25℃		11		nC

Note :

1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.

2、The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3、The EAS data shows Max. rating . The test condition is VDD=36V,VGS =10V,L=0.1mH,IAS =10A

4. The power dissipation is limited by  $150^{\circ}$ C junction temperature

5. The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation

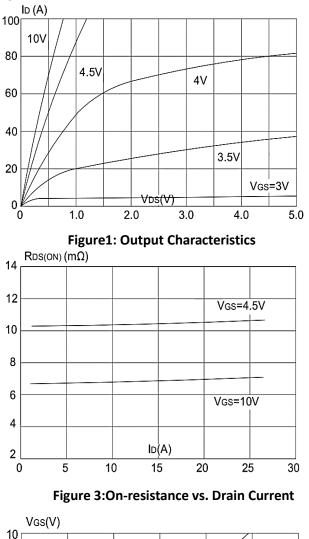
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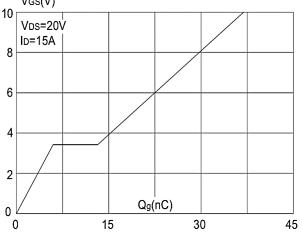


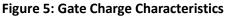
**Typical Characteristics** 

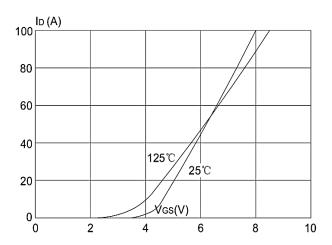
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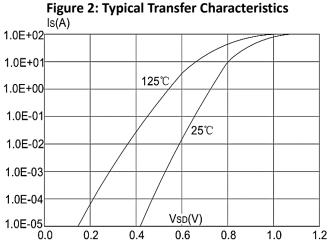
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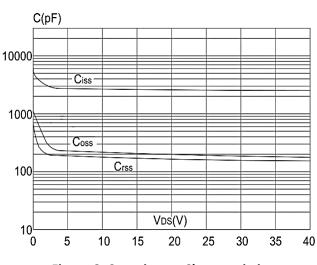








**Figure 4: Body Diode Characteristics** 

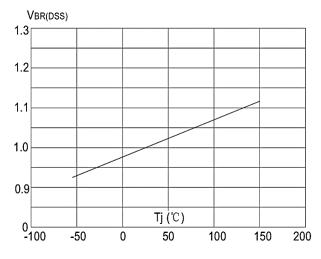


**Figure 6: Capacitance Characteristics** 

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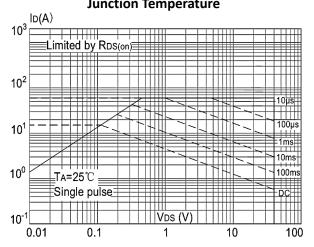


Figure 9: Maximum Safe Operating Area vs. Case Temperature

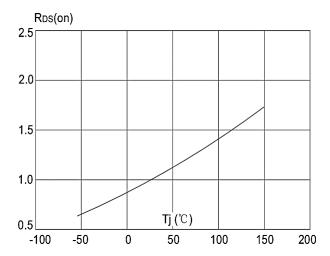


Figure 8: Normalized on Resistance vs Junction Temperature

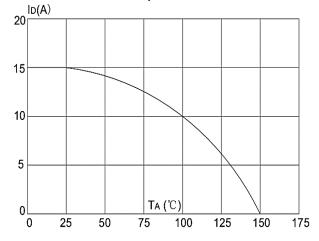
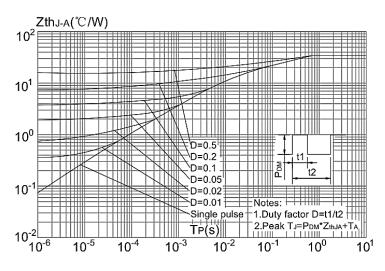
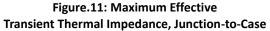


Figure 10: Maximum Continuous Drain Current

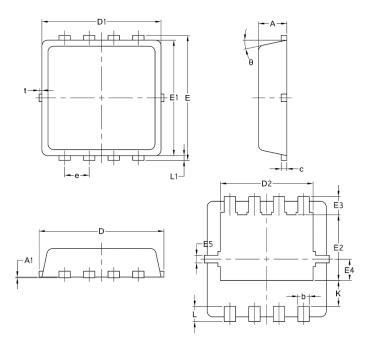






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### Package Mechanical Data-DFN3\*3-8L-JQ Single



	Common			
Symbol	mm			
	Mim	Nom	Max	
А	0.70	0.75	0.85	
A1	/	/	0.05	
b	0.20	0.30	0.40	
С	0.10	0.152	0.25	
D	3.15	3.30	3.45	
D1	3.00	3.15	3.25	
D2	2.29	2.45	2.65	
E	3.15	3.30	3.45	
E1	2.90	3.05	3.20	
E2	1.54	1.74	1.94	
E3	0.28	0.48	0.65	
E4	0.37	0.57	0.77	
E5	0.10	0.20	0.30	
е	0.60	0.65	0.70	
К	0.59	0.69	0.89	
L	0.30	0.40	0.50	
L1	0.06	0.125	0.20	
t	0	0.075	0.13	
Ф	10	12	14	



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### 40V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.0	2021/3/1	Initial release

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AP65N04DF RVE1.0

